

DATASHEET

Chip Infrared LED with Right Angle Lens EAISS3010A3



Features

- Package in 8mm tape on 7" diameter reel
- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photo detector
- Pb free
- The product itself will remain within RoHS compliant version.

Descriptions

EAISS3010A3 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with right angle lens. The device is spectrally matched with silicon photodiode and phototransistor.

Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

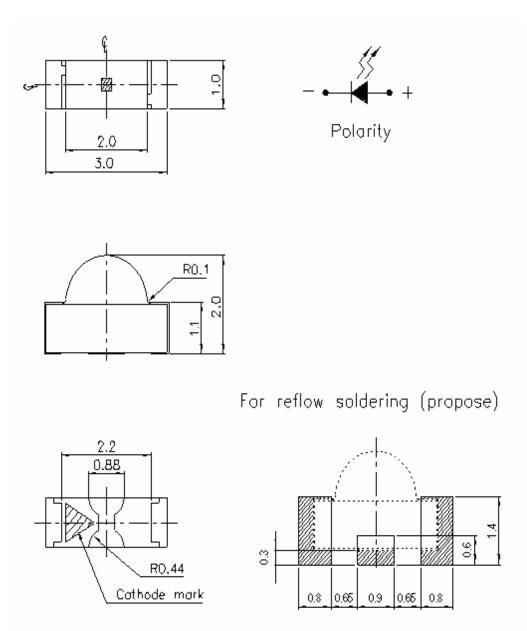
Device Selection Guide

Part Category	Chip Material	Resin Color	
EAISS3010A3	GaAlAs	Water Clear	

Rev:1



Package Dimensions



Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions ±0.1mm



Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Units	
Reverse Voltage	V_R	5	V	
Continuous Forward Current	I_{F}	65	mA	
Power Dissipation at(or below) 25°C Free Air Temperature	P _d	130	mW	
Operating Temperature	$T_{ m opr}$	-25 ~ +85	$^{\circ}$ C	
Storage Temperature	$T_{ m stg}$	-40 ~ +100	$^{\circ}$ C	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Radiant Intensity	Ie	0.70	1.30		mW/sr	
Viewing Angle	2 \theta 1/2		145		deg	
Peak Wavelength	λр		850		nm	$I_F=20mA$
Spectrum Radiation Bandwidth	Δλ		45		nm	
Forward Voltage	V_{F}		1.45	1.65	V	
Reverse Current	I_{R}			10	μ A	V _R =5V



Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.

Ambient Temperature

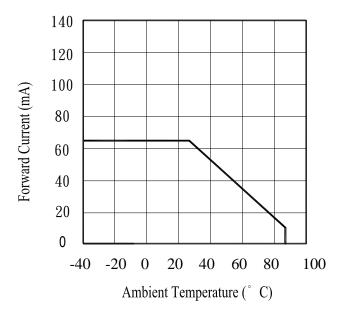


Fig.2 Spectral Distribution

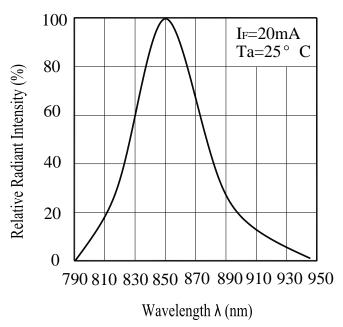


Fig.3 Peak Emission Wavelength
Ambient Temperature

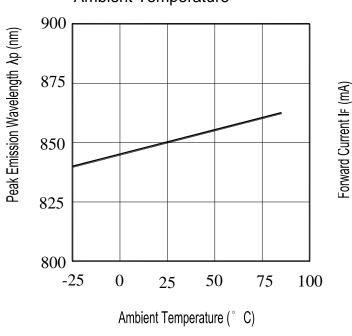
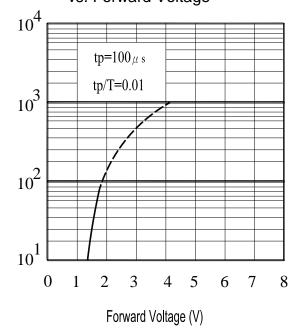


Fig.4 Forward Current vs. Forward Voltage





Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.

Forward Current

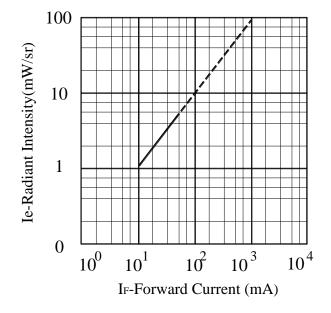
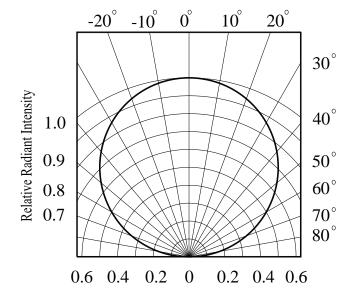


Fig.6 Relative Radiant Intensity vs.

Angular Displacement





Precautions For Use

1. Over-current-proof

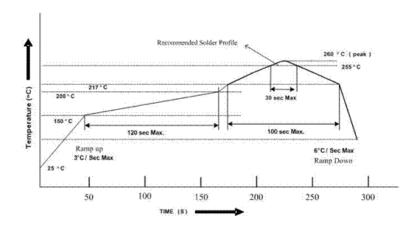
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 ℃ or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 - Baking treatment : 60±5°C for 48 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

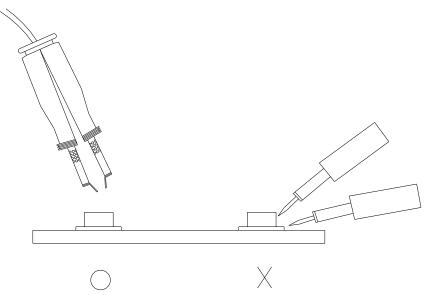


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

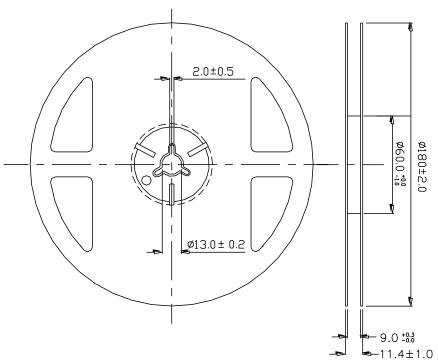
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



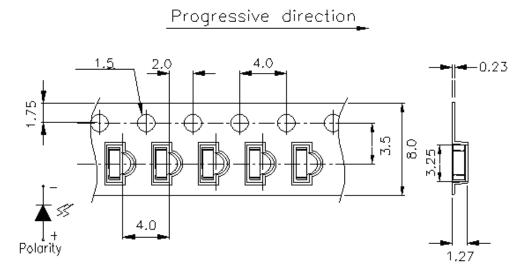


Package Dimensions



Note: The tolerances unless mentioned are ± 0.1 , unit=mm.

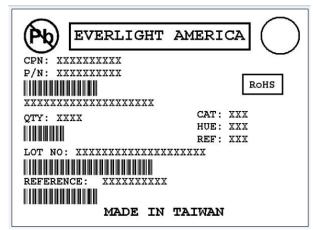
Carrier Taping Dimensions: Loaded Quantity Per Reel 2000PCS/Reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Label Form Specification



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

Notes

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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